Switch-mode Power Rectifiers

DPAK-3 Surface Mount Package

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings
- NRVBD and SBRV Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- ESD Ratings:
 - Machine Model = C
 - Human Body Model = 3B



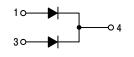
ON Semiconductor®

www.onsemi.com

SCHOTTKY BARRIER RECTIFIERS 6.0 AMPERES, 20 – 60 VOLTS



DPAK CASE 369C



MARKING DIAGRAM



 $\begin{array}{lll} Y &= Year \\ WW &= Work Week \\ B6x0T &= Device Code \\ x &= 2, 3, 4, 5, or 6 \\ G &= Pb-Free Package \end{array}$

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

MAXIMUM RATINGS

		MBRD/NRVBD/SBRV					
Rating	Symbol	620CT	630CT	640CT	650CT	660CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
Average Rectified Forward Current $T_{C} = 130^{\circ}C$ (Rated V _R) Per Diode Per Device	I _{F(AV)}	3 6				A	
Peak Repetitive Forward Current, T _C = 130°C (Rated V _R , Square Wave, 20 kHz) Per Diode	I _{FRM}	6			A		
Nonrepetitive Peak Surge Current – (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	75				A	
Peak Repetitive Reverse Surge Current (2 µs, 1 kHz)	I _{RRM}	1			А		
Operating Junction Temperature (Note 1)	TJ	-65 to +175			°C		
Storage Temperature	T _{stg}	-65 to +175			°C		
Voltage Rate of Change (Rated V _R)	dv/dt	10,000				V/μs	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS PER DIODE

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction-to-Case	$R_{ ext{ heta}JC}$	6	°C/W
Maximum Thermal Resistance, Junction-to-Ambient (Note 2)	R_{\thetaJA}	80	°C/W

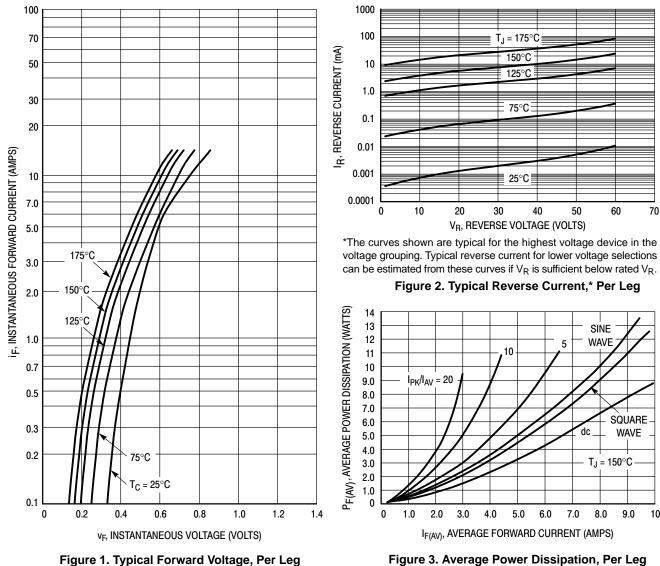
2. Rating applies when surface mounted on the minimum pad size recommended.

ELECTRICAL CHARACTERISTICS PER DIODE

Characteristic	Symbol	Value	Unit	
	V _F	0.7 0.65 0.9 0.85	V	
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_C = 25^{\circ}C$) (Rated dc Voltage, $T_C = 125^{\circ}C$)	i _R	0.1 15	mA	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

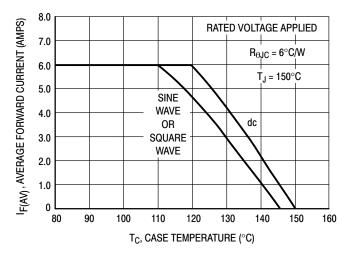


TYPICAL CHARACTERISTICS

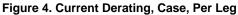
Figure 1. Typical Forward Voltage, Per Leg

70

10



TYPICAL CHARACTERISTICS



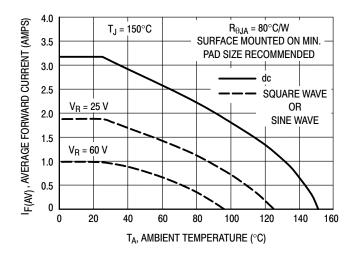
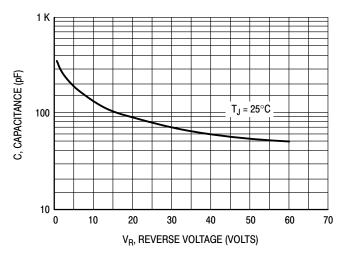


Figure 5. Current Derating, Ambient, Per Leg





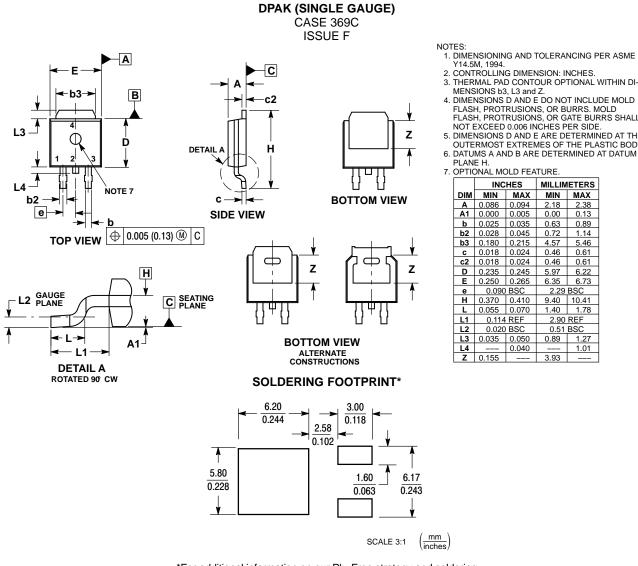
ORDERING INFORMATION

Device	Package	Shipping [†]		
MBRD620CTT4G		2500 / Tape & Reel		
MBRD630CTT4G		2500 / Tape & Reel		
MBRD640CTG		75 Units / Rail		
NRVBD640CTG*		75 Units / Rail		
NRVBD640CTG-VF01*		75 Units / Rail		
MBRD640CTT4G		2500 / Tape & Reel		
NRVBD640CTT4G*		2500 / Tape & Reel		
NRVBD640VCTT4G*		2500 / Tape & Reel		
SBRV640VCTT4G*		2500 / Tape & Reel		
MBRD650CTG		75 Units / Rail		
MBRD650CTT4G		2500 / Tape & Reel		
NRVBD650CTG-VF01*	DPAK (Pb–Free)	2500 / Tape & Reel		
NRVBD650CTT4G*		2500 / Tape & Reel		
NRVBD650CTT4G-VF01*		2500 / Tape & Reel		
MBRD660CTG		75 Units / Rail		
NRVBD660CTG*		75 Units / Rail		
NRVBD660CTG-VF01*		75 Units / Rail		
MBRD660CTRLG		1800 / Tape & Reel		
NRVBD660CTRLG*		1800 / Tape & Reel		
MBRD660CTT4G		2500 / Tape & Reel		
NRVBD660CTT4G*		2500 / Tape & Reel		
SBRV660VCTT4G*	1	2500 / Tape & Reel		
SNRVBD660CTT4G*	1	2500 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. *NRVBD and SBRV Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101

Qualified and PPAP Capable.

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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- FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE. 5. DIMENSIONS D AND E ARE DETERMINED AT THE
- OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 6. DATUMS A AND B ARE DETERMINED AT DATUM

OPTIONAL MOLD FEATURE.					
	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.086	0.094	2.18	2.38	
A1	0.000	0.005	0.00	0.13	
b	0.025	0.035	0.63	0.89	
b2	0.028	0.045	0.72	1.14	
b3	0.180	0.215	4.57	5.46	
С	0.018	0.024	0.46	0.61	
c2	0.018	0.024	0.46	0.61	
D	0.235	0.245	5.97	6.22	
Е	0.250	0.265	6.35	6.73	
е	0.090	BSC	2.29 BSC		
н	0.370	0.410	9.40	10.41	
L	0.055	0.070	1.40	1.78	
L1	0.114	0.114 REF		2.90 REF	
L2	0.020	BSC	0.51	BSC	
L3	0.035	0.050	0.89	1.27	
L4		0.040		1.01	
Z	0.155		3.93		